



## Product Summary

BV <sub>DSS</sub>	RDS(ON) Max	Ι <sub>D</sub> T <sub>A</sub> = +25°C
	$77m\Omega@V_{GS} = -10V$	-3.5A
-30V	$95m\Omega@V_{GS} = -4.5V$	-3.0A
	150mΩ@ $V_{GS}$ = -2.5V	-2.4A

## **Description and Applications**

This new generation MOSFET has been designed to minimize the on-state resistance (R<sub>DS(ON)</sub>) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

- **DC-DC Converters**
- **Power Management Functions**
- Analog Switch

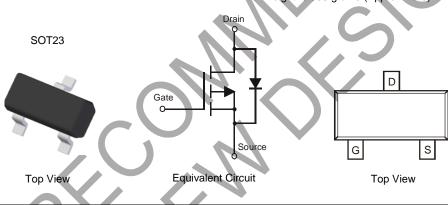
### P-CHANNEL ENHANCEMENT MODE MOSFET

## **Features and Benefits**

- Low On-Resistance
- Low Gate Threshold Voltage
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability An Automotive-Compliant Part is Available Under
- Separate Datasheet (DMP3130LQ)

## Mechanical Data

- Case: SOT23
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 @3
- Terminal Connections: See Diagram
- Weight: 0.008 grams (Approximate)



## Ordering Information (Note 4)

Part Number	Case	Packaging
DMP3130L-7	SOT23	3000/Tape & Reel

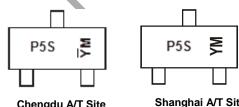
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. Notes:

2. See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green"

and Lead-free. 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + CI) and <1000ppm antimony compounds

For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

# **Marking Information**



P5S = Product Type Marking Code YM = Date Code Marking for SAT (Shanghai Assembly/ Test Site) YM = Date Code Marking for CAT (Chengdu Assembly/ Test Site) Y or  $\overline{Y}$  = Year (ex: F = 2017) ber)

Chengdu A/T Site

hanghai A/T Site	

M = Month (ex: 9 = Septem)

Date Code Key 2009 2010 2011 2015 2016 2017 2018 Year 2008 2012 2013 2014 Code V W v В С D Е F Х 7 A Month Feb Sep Dec Jan Mar Apr May Jun Jul Aug Oct Nov Code 8 0 3 9 N D 1 2 4 5 6

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# Maximum Ratings (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic			Symbol	Value	Unit
Drain-Source Voltage			V <sub>DSS</sub>	-30	V
Gate-Source Voltage			V <sub>GSS</sub>	±12	V
	Steady State	T <sub>A</sub> = +25°C T <sub>A</sub> = +70°C	ID	-3.0 -2.6	А
Continuous Drain Current (Note 5) $V_{GS} = -4.5V$	t<10s	T <sub>A</sub> = +25°C T <sub>A</sub> = +70°C	ID	-4.1 -3.2	А
Maximum Continuous Body Diode Forward Current (Note 5)			ls	-1.6	А
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)			I <sub>DM</sub>	-20	А

## **Thermal Characteristics**

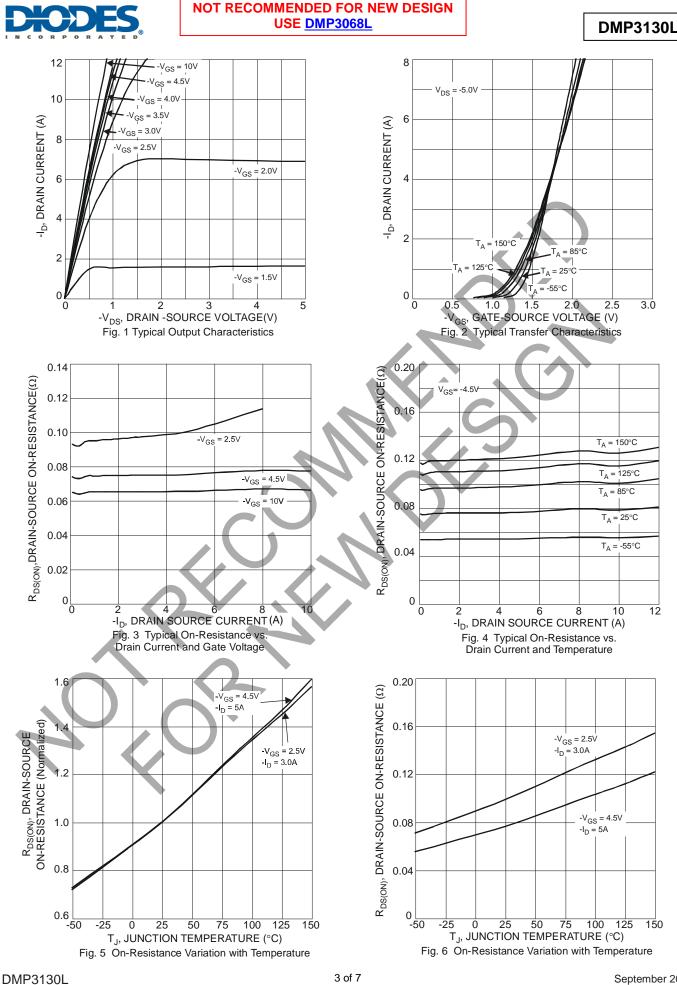
Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)	T <sub>A</sub> = +25°C	PD	0.7	W
	T <sub>A</sub> = +70°C		0.4	vv
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	Р	184	°C/W
memai Resistance, sunction to Ambient (Note 3)	t<10s	R <sub>0</sub> JA	115	0/11
Total Power Dissipation (Note 6)	T <sub>A</sub> = +25°C	Po	1.3	• W
Total Fower Dissipation (Note 0)	T <sub>A</sub> = +70°C	FD	0.8	V V
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	P	94	
Thermal Resistance, Junction to Amblent (Note 0)	t<10s	R <sub>θ</sub> JA	61	°C/W
Thermal Resistance, Junction to Case		R <sub>θJC</sub>	25	
Operating and Storage Temperature Range		TJ, TSTG	-55 to +150	°C

# Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)	Oyimbol		Тур	INUX	Onic		
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	-30			V	$V_{GS} = 0V, I_{D} = -250\mu A$	
Zero Gate Voltage Drain Current	IDSS	_		-1	μA	$V_{DS} = -30V$ , $V_{GS} = 0V$	
Gate-Body Leakage	IGSS			±100	nA	$V_{GS} = \pm 12V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)						·	
Gate Threshold Voltage	V <sub>GS(TH)</sub>	-0.6		-1.3	V	$V_{DS} = V_{GS}$ , $I_D = -250 \mu A$	
			59	77		V <sub>GS</sub> = -10V, I <sub>D</sub> = -4.2A	
Static Drain-Source On-Resistance	R <sub>DS(ON)</sub>		73	95	mΩ	$V_{GS} = -4.5V, I_D = -4A$	
			115	150		$V_{GS} = -2.5V, I_D = -3A$	
Forward Transconductance	<b>g</b> fs		8		S	$V_{DS} = -5V, I_D = -4A$	
Source-Drain Diode Forward Voltage	V <sub>SD</sub>	—	-0.8	-1.25	V	$V_{GS} = 0V, I_{S} = -3.0A$	
DYNAMIC CHARACTERISTICS (Note 8)							
Input Capacitance	Ciss	_	432	864	pF		
Output Capacitance	Coss	_	87	174	pF	│V <sub>DS</sub> = -15V, V <sub>GS</sub> = 0V │f = 1.0MHz	
Reverse Transfer Capacitance	Crss		62	124	pF		
Gate Resistance	R <sub>G</sub>		4.04		Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1.0MHz$	
SWITCHING CHARACTERISTICS (Note 8)							
Total Gate Charge	Q <sub>G</sub>	_	5.9	11.8		$V_{DS} = -15V, V_{GS} = -4.5V, I_D = -4.0A$	
Total Gate Gharge	QG	_	12	24	nC	$V_{DS} = -15V, V_{GS} = -10V, I_D = -4.0A$	
Gate-Source Charge	Q <sub>GS</sub>	_	1.0	2.0	no	$V_{DS} = -15V$ , $V_{GS} = -4.5V$ , $I_{D} = -4.0A$	
Gate-Drain Charge	Q <sub>GD</sub>		3.1	6.2		$v_{DS} = -15v, v_{GS} = -4.5v, I_D = -4.0A$	
Turn-On Delay Time	t <sub>D(ON)</sub>		4.6	9.2			
Rise Time	t <sub>R</sub>		6.5	13.0	ns	$V_{DS} = -15V, V_{GS} = -10V,$	
Turn-Off Delay Time	t <sub>D(OFF)</sub>		27.8	55.6	115	$I_D = -1A, R_G = 6.0\Omega$	
Fall Time	t <sub>F</sub>	_	15.0	30.0			

Device mounted on FR-4 PC board, with minimum recommended pad layout, single sided.
Device mounted on FR-4 substrate PC board, 2oz copper, with thermal vias to bottom layer 1inch square copper plate.
Short duration pulse test used to minimize self-heating effect.
Guaranteed by design. Not subject to production testing.

Notes:



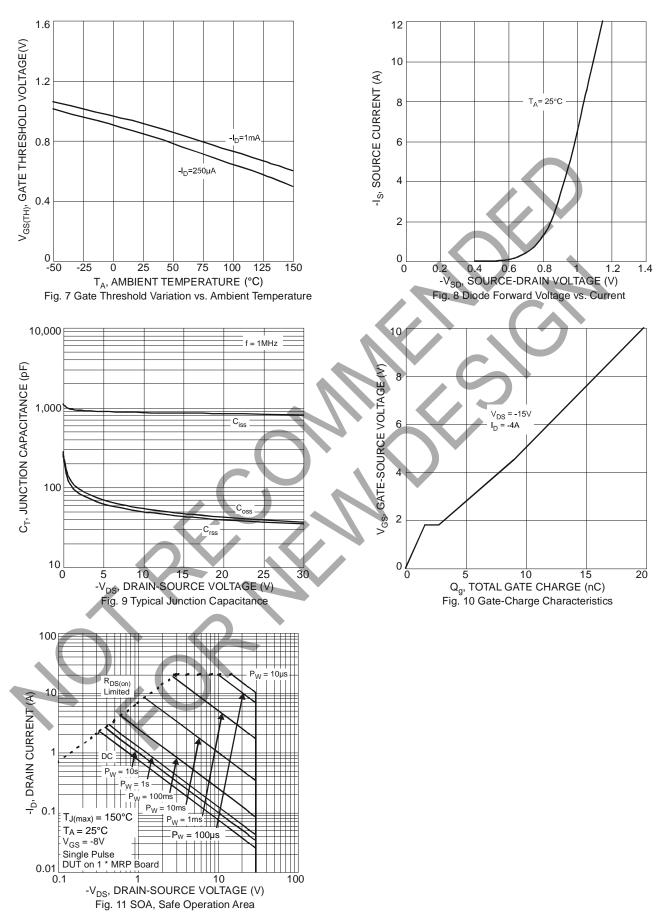
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### NOT RECOMMENDED FOR NEW DESIGN USE <u>DMP3068L</u>

DMP3130L

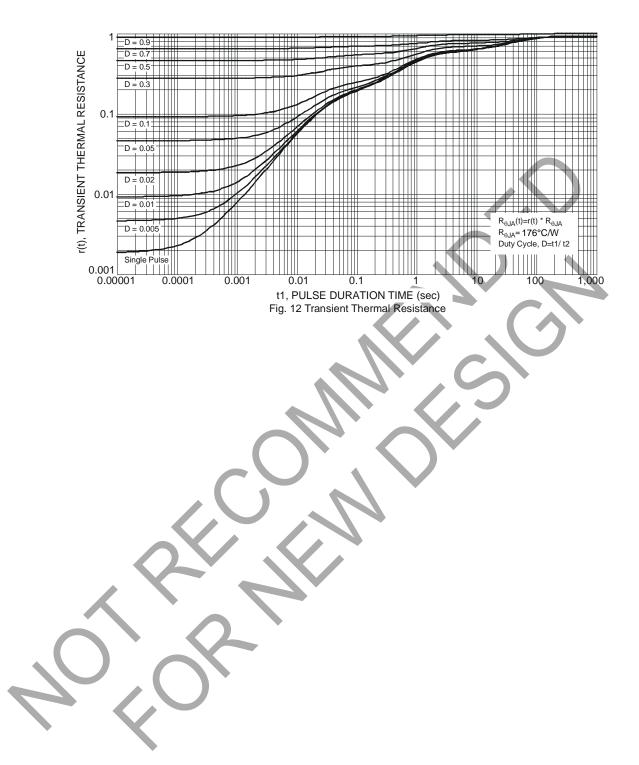


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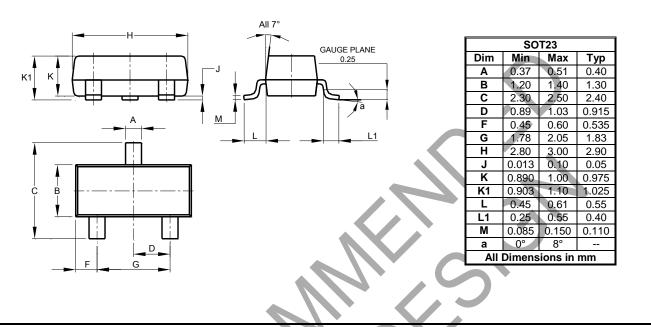
DMP3130L





## **Package Outline Dimensions**

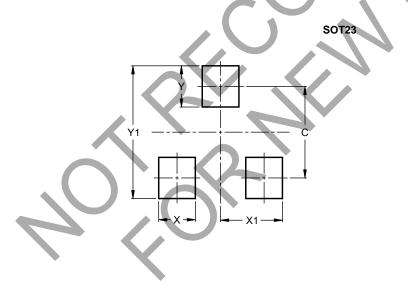
Please see http://www.diodes.com/package-outlines.html for the latest version.



SOT23

# **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.



Dimensions	Value (in mm)
С	2.0
Х	0.8
X1	1.35
Y	0.9
Y1	2.9



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